

#### **Features**

- Epitaxial Construction
- Low forward voltage drop
- Low profile package
- Guardring for overvoltage protection
- High surge Current Capability
- Easy pick and place

#### **Mechanical Data**

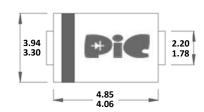
• Case: DO-214AA/SMB

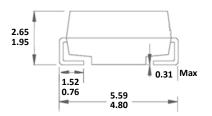
• Terminals: Solderable per MIL-STD-750,

Method 2026

Weight: 0.095grams (approx.)

#### **SMB**





Dimensions in inches and millimeters



### Maximum Ratings (TA=25°C unless otherwise noted)

Rating at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%

Parameter	Symbol	SK110LB	UNITS
Max. Recurrent Peak Reverse Voltage	$V_{RRM}$	100	Volts
Max. RMS Voltage	$V_{RMS}$	70	Volts
Max. DC Blocking Voltage	V <sub>DC</sub>	100	Volts
Max. Average Forward Rectified Current	I <sub>F(AV)</sub>	1.0	Amps
Peak Forward Surge Current 8.3ms single half sine -wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>	50	Amps
Max. Instantaneous Forward Voltage at 1.0A	V <sub>F</sub>	0.75	Volts
Max. DC Reverse Current $T_A=25^{\circ}$ C Max. DC Reverse Current $T_A=100^{\circ}$ C	I <sub>R</sub>	0.1 5	mA
Typ. Thermal Resistance Typ. Junction to Ambient	R <sub>⊖JL</sub> R <sub>⊖JA</sub>	30 85	°C/W
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	οС



### **Rating and Characteristics Curves**

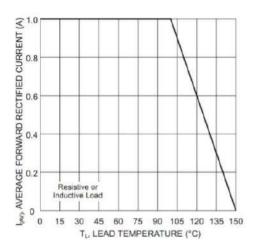


Fig. 1 Forward Current Derating Curve

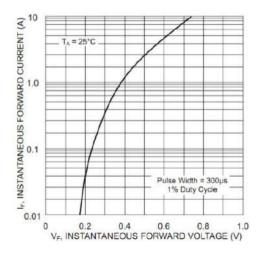


Fig. 3 Max. Non-Repetitive Peak Fwd Surge

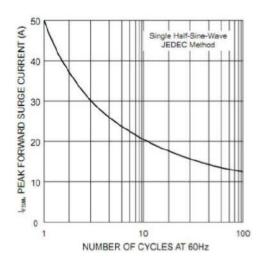


Fig. 2 Typ. Forward Characteristics

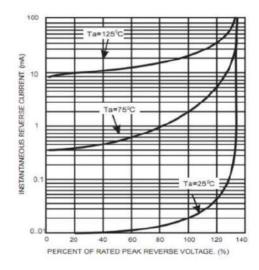
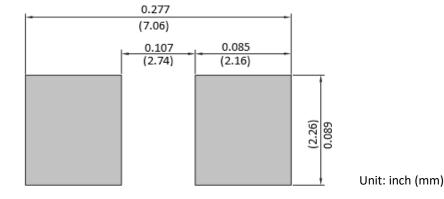


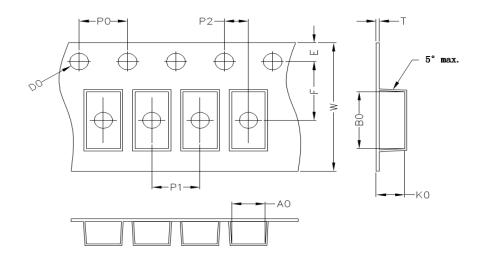
Fig. 4 Typ. Reverse Characteristics

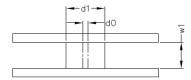
### **Suggested Pad Layout**

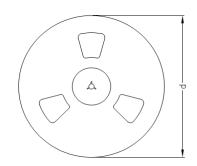




Packaging Specifications											
Dookses	A0	В0	K0	D0	Е	F	P0	P1	P2	Т	W
Package	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)	(mm)
SMA	2.8±0.1	5.33±0.1	2.36±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	4.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMB	3.8±0.1	5.40±0.1	2.45±0.1	1.55±0.1	1.75±0.1	5.50±0.1	4.0±0.1	8.0±0.01	2±0.1	0.25±0.1	9.4±0.1
SMC	6.05±0.1	8.31±0.1	2.54±0.1	1.55±0.1	1.75±0.1	7.50±0.1	4.0±0.1	8.0±0.05	2±0.1	0.25±0.1	12±0.1







Package	D1 (mm)	D0 (mm)	W1 (mm)	D (mm)
SMA	75	13.5	13.5	330
SMB	75	13.5	13.5	330
SMC	75	13.5	17.0	330

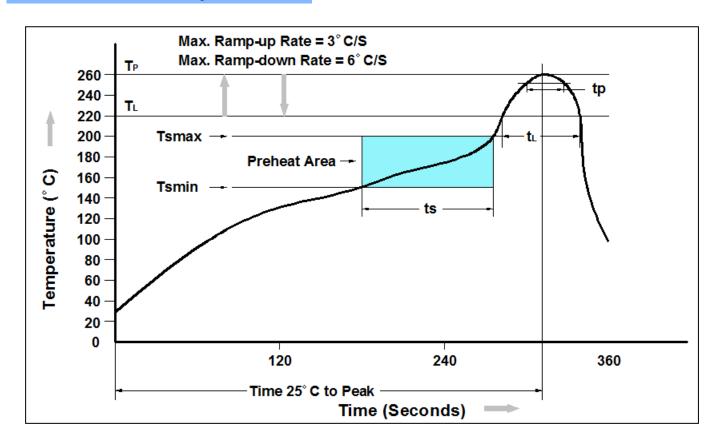
NOTE: The tolerance of reel is ±2mm

# Ordering Information

Part Number	Description	Quantity
SK110LB	SMB Reel	3000 pcs



## Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tLto tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.





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